

Autolad1G

(UL ANSI: FR-4.1) Halogen Free, Mid-Loss, Automotive-used HDI Material

FEATURES

• Lead-free compatible and excellent CAF resistance

- Lower Z-CTE and better dimensional stability in ultra-thin specification.
- Halogen, antimony and red phosphorous free

APPLICATIONS

Specified for advanced HDI automotive electronics, like Camera-modulus,

GENERAL PROPERTIES

Test Items		Test Method	Test Condition	Unit	Typical Value
Tg		IPC-TM-650 2.4.25D	DSC	°C	173
Td		IPC-TM-650 2.4.24.6	TGA (5% W.L)	°C	400
T288		IPC-TM-650 2.4.24.1	TMA	min	60
CTE (Z-axis)		IPC-TM-650 2.4.24	Before Tg	ppm/°C	35
		IPC-TM-650 2.4.24	After Tg	ppm/°C	189
		IPC-TM-650 2.4.24	50-260 ℃	%	2.3
Dk (R/C: 50%)	1GHz	IPC-TM-650 2.5.5.9	C-24/23/50	-	4.30
	10GHz	IPC-TM-650 2.5.5.5		-	4.05
Df (R/C: 50%)	1GHz	IPC-TM-650 2.5.5.9	C-24/23/50	-	0.010
	10GHz	IPC-TM-650 2.5.5.5		-	0.012
Volume Resistivity		IPC-TM-650 2.5.17.1	C-96/35/90	MΩ-cm	6.0×10 ⁸
Surface Resistivity		IPC-TM-650 2.5.17.1	C-96/35/90	ΜΩ	8.0×10 ⁷
Dielectric Breakdown		IPC-TM-650 2.5.6	D-48/50+D- 0.5/23	kV	45+kV NB
Peel Strength (1oz)		IPC-TM-650 2.4.8	288℃/10s	N/mm [lb/in]	1.35 [7.71]
Flexural Strength (LW/CW)		IPC-TM-650 2.4.4	Α	Мра	550/430
Flexural Modulus (LW/CW)		IPC-TM-650 2.4.4	A	GPa	28/25
Water Absorption		IPC-TM-650 2.6.2.1	D-24/23	%	0.09
Flammability		UL94	C-48/23/50	Rating	V-0

Remark:

- 1. All the typical value is based on the 1.6mm (8*7628) specimen. The Dk and Df value based on 50% RC.
- 2. All the typical value listed above is for your reference only, please turn to Shengyi Technology Co., Ltd for detailed information, and all rights from this data sheet are reserved by Shengyi Technology Co., Ltd.

Explanations: C=Humidity conditioning; D=Immersion conditioning in distilled water; E=Temperature conditioning.

Autolad1GB PREPREG

(UL ANSI: FR-4.1) Bonding Prepreg for Autolad1G

PREPREG PARAMETERS

Glass fabric type	Resin content (%)	Cured thickness (mm)
	72	0.051
106	75	0.056
	77	0.061
	70	0.058
1067	72	0.064
	75	0.071
	65	0.076
1080/1078	69	0.086
	71	0.094
	57	0.102
3313	60	0.109
	62	0.114

Other type, resin content and size could be available upon request.

HOT PRESSING CYCLE

Kissing pressure: 70-100PSI (5-7Kg/cm²)

• Full pressure: 350-430PSI (25-30Kg/cm²) apply at 80-100℃ material temperature.

Ramp-up rate: 1.5-2.5 ℃/min (80-140 ℃)

Curing condition: 180 ℃/60min

Cooling rate: <2°C/min (≤1.5°C/min is preferred)

The hot-pressing parameter is for your reference only. If you need any more detail information, please turn to Shengyi Technology Co., Ltd.

STORAGE CONDITION

- 3 months when stored at < 23[°]C and <50% RH.
- 6 months when stored at <5℃. Normalize in room temperature for at least 4h before using.
- Beware of moisture, always keep wrapped in damp-proof material. Kept in normal condition, prepreg might absorb moisture and its bonding strength would be weakened.
- Avoid UV-rays and strong light.